
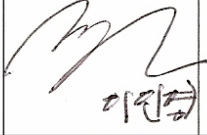




APPROVAL SHEET

Type : Multilayer Chip Antenna
Part No. : ALA931C5

	Check	Consent	Approval



	Written	Checked		Approved
Amotech	 조영호	 이준호	 김희	 김희
	12/18	12/18	12/18	12/18

2008. 2. 7

AMOTECH Co., Ltd.

Content

1. Revision History	3
2. Specifications	4
2.1 Electrical Specifications		
2.2 Mechanical Specifications		
2.3 Index method of Part No. & Lot No.		
3. Test Method	6
3.1 VSWR		
3.2 Radiation Gain		
4. Reliability Test	7
5. Soldering Recommend	8
5.1 Reflow profile for Pb-free		
5.2 PCB land pattern		
6. Structure and Material	9
6.1 Material		
6.2 Equivalent symbol		
7. Cautions	10
8. Packing Method	10
8.1 Carrier-tape		
8.2 Reel		
8.3 Packing box		
9. Manufacture & Place	12

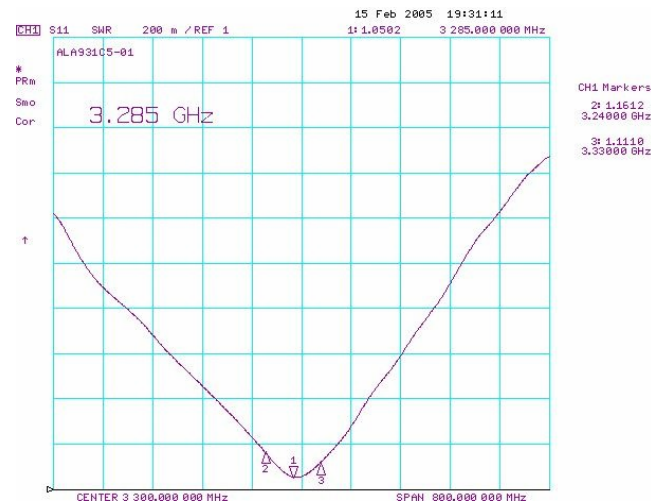
1. Revision Record

Date	Title	Content	Remark
2006.12.18		New drawing up	

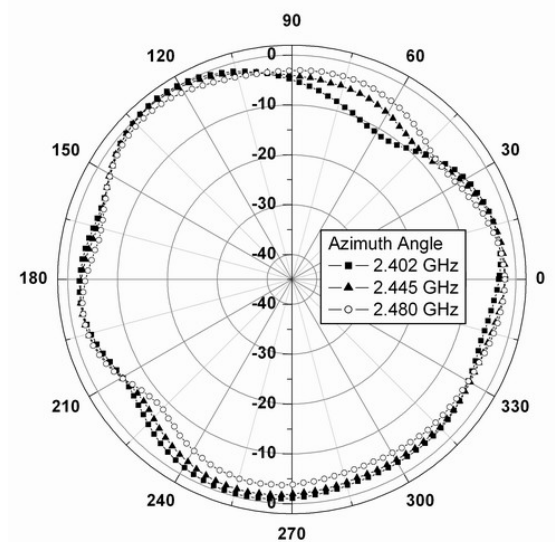
2. Specifications

2.1 Electrical specifications

No	Item	Spec.	Remark
1	Frequency Range	2400~2500	ISM Band
2	VSWR	Max. 3.0:1 @3285±45 MHz	On manual jig
3	Radiation Gain	Max. -1 dBi @azimuth co-pol.	Measured after matching on testboard
4	Radiation Pattern	Omni-directional	
5	Impedance	Nominal 50 Ω	



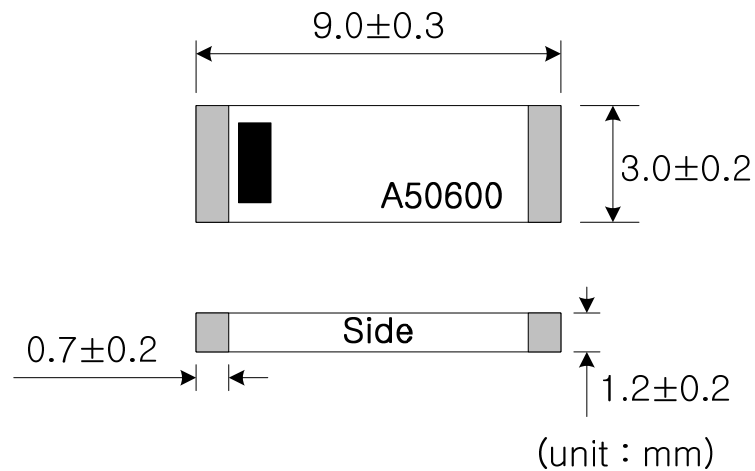
[VSWR : measured on manual jig]



[Radiation Gain : Measured on Ref. Board]

2.2 Mechanical specifications

No	Item	Spec.		Unit
1	Dimensions	W	9.0 ± 0.3	mm
		D	3.0 ± 0.2	
		H	1.2 ± 0.2	
2	Unit Weight	97 ± 9		mg
3	Operation Temp.	$-30 \sim +70$		°C
4	Storage Temp.	$-40 \sim +85$		°C



[Chip Antenna dimension]

2.3 Index method of Part No. & Lot No.

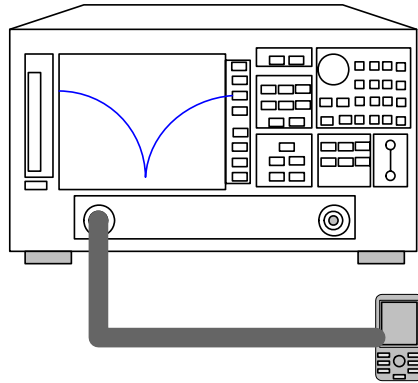
Part No.	<u>ALA</u> (1)	931 (2)	<u>C5</u> (3)
(1) : Amotech Antenna			
(2) : Chip size			
(3) : Version & frequency			

Lot No.	<u>MA</u> (1)	<u>09</u> (2)	<u>A5</u> (3)	<u>0506</u> (4)	<u>01</u> (5)
(1) : Mass product Antenna					
(2) : Chip size					
(3) : Version & frequency					
(4) : Y/M					
(5) : Serial No. of product					

3. Test Method

3.1 VSWR

Equipment : Network Analyzer 8753ES

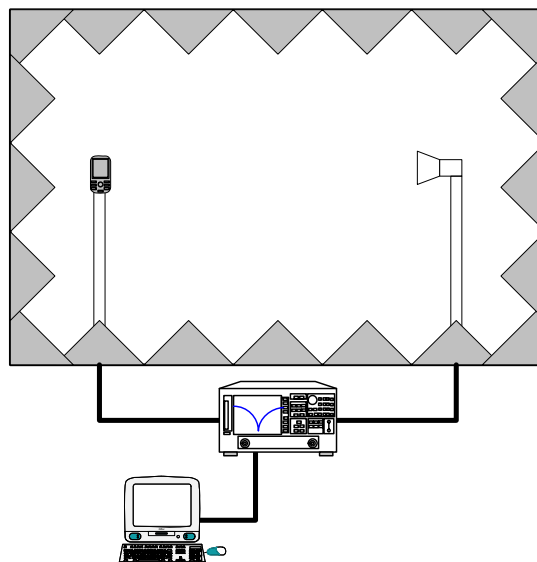


[Test procedure]

- ① Setup as shown picture.
- ② Calibrate Network Analyzer in frequency range of $f_0 \pm 400$ MHz, verify that the value of return loss(S_{11}) is under -55dB with termination(50Ω)
- ③ After connect a mobile set or manual jig for single chip antenna to Network Analyzer, measure the max. value of VSWR in frequency range of spec.

3.2 Radiation gain

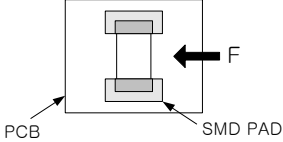
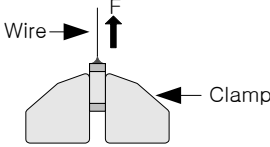
Equipment : Anechoic chamber , Network Analyzer 8753ES



[Test procedure]

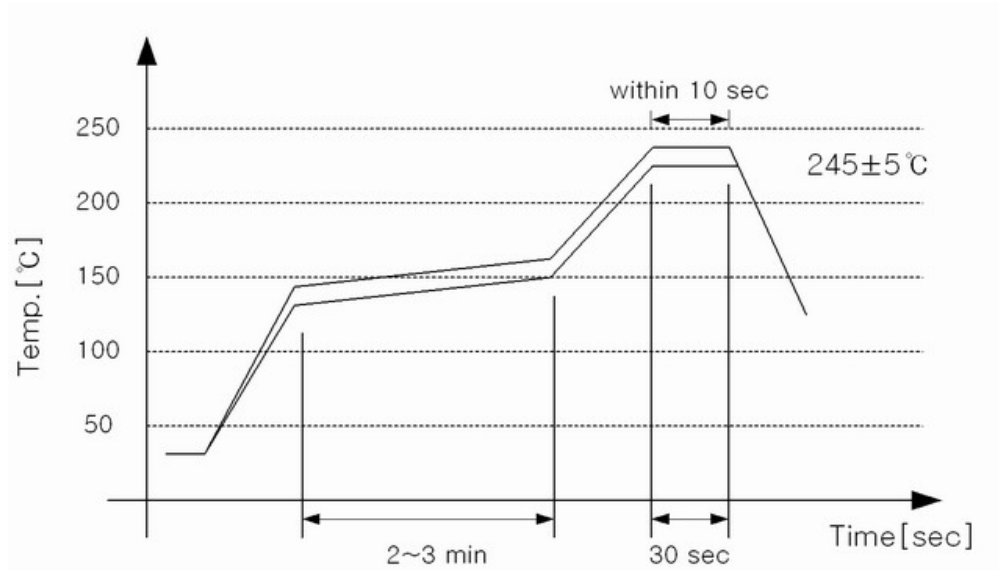
- ① Calibrate network analyzer and anechoic chamber using reference horn antenna.
- ② Set-up operation software (frequency, angle step, etc.)
- ③ After connecting AUT on holder, measure radiation gain.

4. Reliability Test

No	ITEM	TEST CONDITION	TEST REQUIREMENTS
1	Adhesive Strength of Termination	<p>1. Applied force on SMD chip till detached point from PCB.</p> 	<p>1. No mechanical damage by forces applied on the right. 2. Strength (F) > 7 kgf</p>
2	Tensile Strength	<p>1. Wire : 0.6~0.8 tined Cu wire</p> 	<p>1. No mechanical damage by forces applied on the right. 2. Strength (F) > 3 kgf</p>
3	Thermal Shock (Temperature Cycle)	<p>1. 1 cycle / step 1 : $-40 \pm 3^{\circ}\text{C}$, 30 min step 2 : $+125 \pm 3^{\circ}\text{C}$, 30 min 2. Number of cycle : 30 3. Measure after left for 48 hrs min. at room temperature</p>	<p>1. No visual damage 2. Within electric spec (VSWR)</p>
4	High Temperature Resistance	<p>1. Temperature : $+125 \pm 5^{\circ}\text{C}$ 2. Time : 1000 ± 24 hrs 3. Measure f_c after left for 24 hrs min. at room temperature</p>	<p>1. No visual damage 2. Within electric spec (VSWR)</p>
5	Low Temperature Resistance	<p>1. Temperature : $-40 \pm 5^{\circ}\text{C}$ 2. Time : 1000 ± 24 hrs 3. Measure f_c after left for 48 hrs min. at room temperature</p>	<p>1. No visual damage 2. Within electric spec (VSWR)</p>
6	Humidity (Steady Condition)	<p>1. Humidity : 85 % RH 1. Temperature : $+85 \pm 3^{\circ}\text{C}$ 2. Time : 1000 ± 24 hrs 3. Measure f_c after left for 48 hrs min. at room temperature</p>	<p>1. No visual damage 2. Within electric spec (VSWR)</p>

5. Soldering Recommend

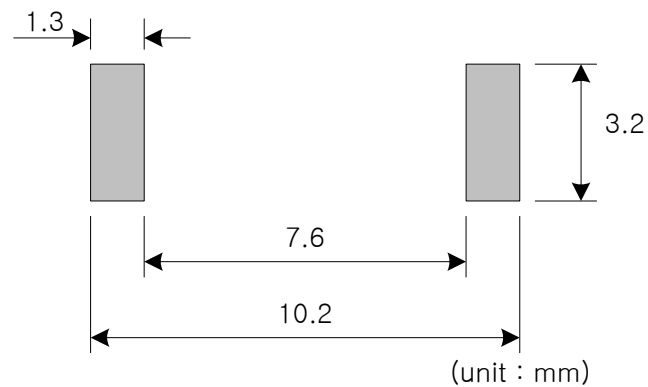
5.1 Reflow profile for Pb-free



This product is designed for reflow soldering only. Do not use flow (wave) soldering.

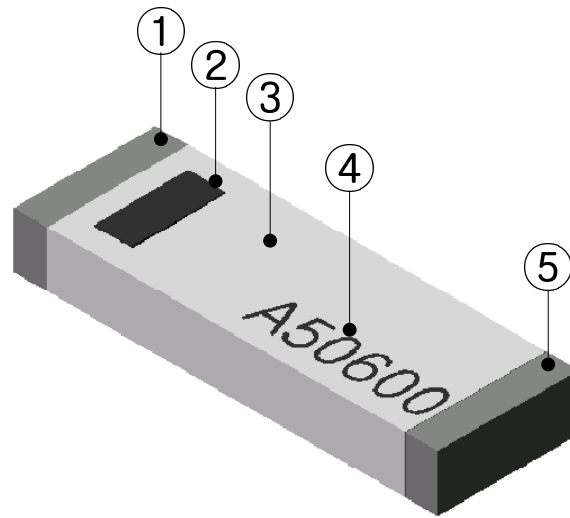
- ① Use non-activated flux (Cl content 0.2% max.)
- ② Follow the recommended soldering conditions to avoid damage.
- ③ Reflow-cycle is max. 3 times.

5.2 PCB land pattern



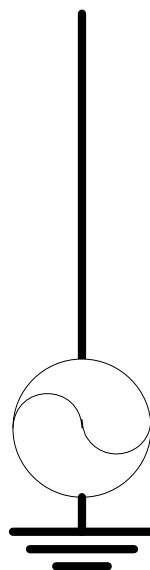
6. Structure and Material

6.1 Material



No	Part	Function	Material
1	External Electrode	Soldering, Feeding	Ag/Ni/Sn
2	Direction Index	Feeding Index	Ceramic
3	Ceramic Body	–	Ceramic
4	Text	Part No. Index	Ceramic
5	External Electrode	Soldering	Ag/Ni/Sn

6.2 Equivalent symbol

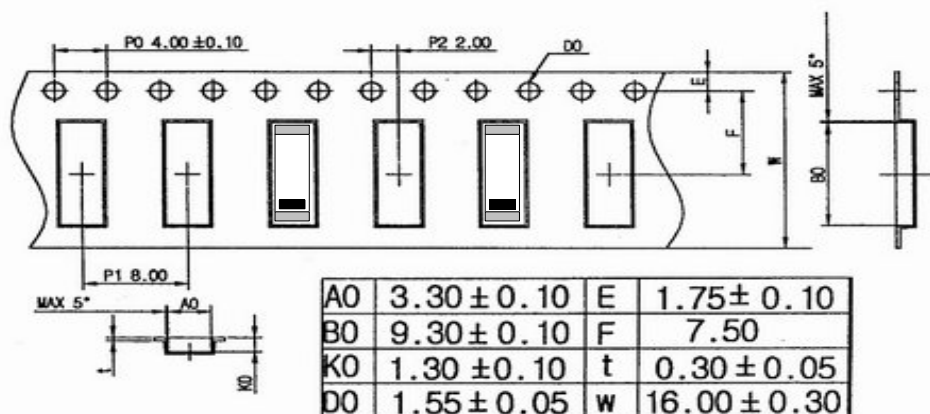


7. Cautions

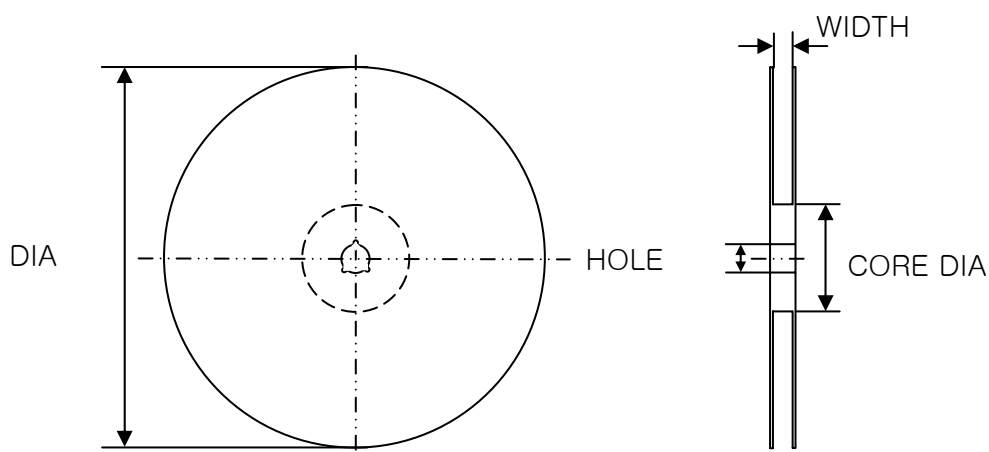
- ① Storage environment must be at ambient temperature of 15~35℃ and ambient humidity of 45~75 % RH. (MSL Level 2)
- ② Chip antenna can experience degradation of termination solder ability when subjected to high temperature of humidity, or if exposed to sulfur or chlorine gases.
- ③ Avoid mechanical shock (ex. falling) to the chip antenna to prevent mechanical cracking inside of the ceramic dielectric due to its own weight.

8. Packing Method

8.1 Carrier-tape



8.2 Reel



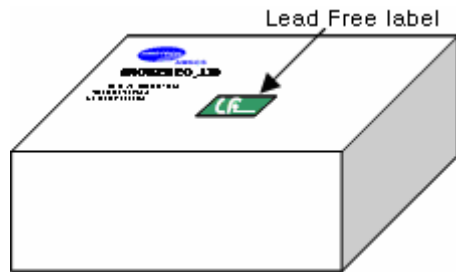
item	DIA	WIDTH	CORE DIA	HOLE
dimension(mm)	180.0 ± 0.3	17.0 ± 0.3	60.0 ± 1	13.0 ± 0.5

8.3 Packing box

8.3.1 Small box

Size : 185 (W) x 185 (D) x 68 (H) (mm)

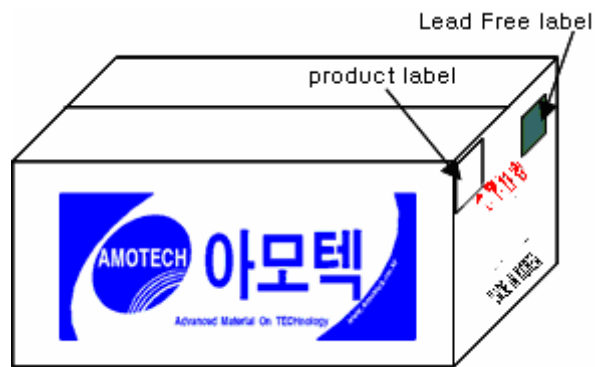
Q'TY : 3 reel (1,000 ea/reel × 3 reel = 3,000 ea)



8.3.2 Middle box

Size : 365 (W) x 200 (D) x 200 (H) (mm)

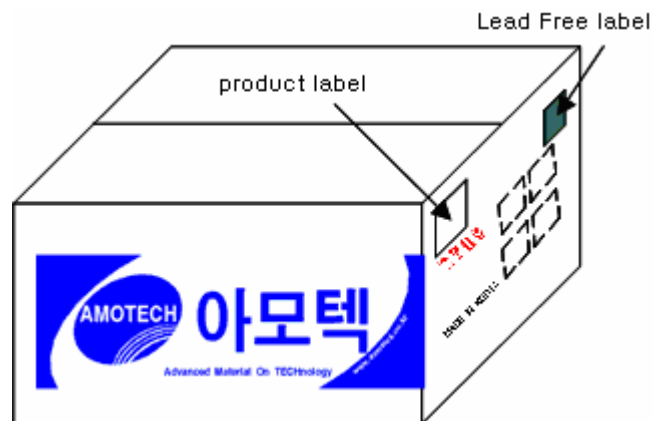
Q'TY : 5 small box(3,000 ea/small box × 5 small box = 15,000 ea)



8.3.3 Large box

Size : 390 (W) x 390 (D) x 280 (H) (mm)

Q'TY : 14 small box(3,000 ea/ small box × 14 small box = 42,000 ea)



9. Manufacture and Place

9.1 Manufacture

Amotech Co., Ltd

9.2 Place

5B 1L, Namdong Industrial Complex, 617 Namchondong, Namdonggu,
Incheon, Korea



Test Report No. F690501/LF-CTSGP06-24480

Date: September 25, 2006

Page 1 of 3

To: **AMOTECH CO., LTD.**
5BL-1L, 617
Namchon-dong
Namdong-gu
INCHEON 405-100
Korea

The following merchandise was submitted and identified by the client as :

Commodity : Multilayer Chip Antenna
SGS File No. : GP06-24480
Received Date : September 18, 2006
Test Performing Date : September 19, 2006
Test Performed : SGS Testing Korea tested the sample(s) selected by applicant with following results
Test Results : For further details, please refer to following page(s)

Jade Jang
Monet Jeong
Jully Oh
Jerry Jung
/Testing Person

SGS Testing Korea Co. Ltd.

Jeff Jang / Chemical Lab Mgr



Test Report No. F690501/LF-CTSGP06-24480

Date: September 25, 2006

Page 2 of 3

Sample No. : GP06-24480.001
Sample Description : Multilayer Chip Antenna
Style/Item No. : Multilayer Chip Antenna

Heavy Metals

Test Items	Unit	Test Method	MDL	Results
Cadmium (Cd)	mg/kg	US EPA 3050B(1996), US EPA 6010B(1996), ICP	0.5	N.D.
Lead (Pb)	mg/kg	US EPA 3050B(1996), US EPA 6010B(1996), ICP	5	N.D.
Mercury (Hg)	mg/kg	US EPA 3052(1996), US EPA 6010B(1996), ICP	2	N.D.
Hexavalent Chromium (Cr VI)	mg/kg	US EPA 3060A(1996), US EPA 7196A(1992), UV	1	N.D.

Flame Retardants-PBBs/PBDEs

Test Items	Unit	Test Method	MDL	Results
Monobromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Dibromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tribromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tetrabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Pentabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Hexabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Heptabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Octabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Nonabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Decabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Monobromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Dibromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tribromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tetrabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Pentabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Hexabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Heptabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Octabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Nonabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Decabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.

NOTE: (1) N.D. = Not detected.(<MDL)
(2) ppm = mg/kg
(3) MDL = Method Detection Limit
(4) - = No regulation
(5) ** = Qualitative analysis (No Unit)
(6) Negative = Undetectable / Positive = Detectable

This Test Report is issued by the Company subject to its General Conditions of Service printed overleaf. Attention is drawn to the limitations of liability, indemnification and jurisdictional issues defined therein. The results shown in this test report refer only to the sample(s) tested unless otherwise stated. This Test Report cannot be reproduced, except in full, without prior written permission of the Company.



Picture of Sample as Received:



*** End ***

- NOTE:
- (1) N.D. = Not detected.($<$ MDL)
 - (2) ppm = mg/kg
 - (3) MDL = Method Detection Limit
 - (4) - = No regulation
 - (5) ** = Qualitative analysis (No Unit)
 - (6) Negative = Undetectable / Positive = Detectable